SCLS432A - SEPTEMBER 1999 - REVISED NOVEMBER 1999

8 Vcc

7 1 1Y

6 2B

5 🛛 2A

DCT PACKAGE (TOP VIEW)

1A

1B 🛙

2Y [

GND [

2

3

Δ

- *EPIC*[™] (Enhanced-Performance Implanted CMOS) Process
- Operating Range 2-V to 5.5-V V_{CC}
- Packaged in Plastic Small-Outline Transistor Package

description

The SN74AHC2G02 contains dual 2-input NOR gates that perform the Boolean function $Y = \overline{A} \cdot \overline{B}$ or $Y = \overline{A} + \overline{B}$ in positive logic.

The SN74AHC2G02 is characterized for operation from -40°C to 85°C.

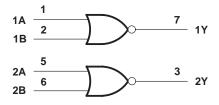
FUNCTION TABLE (each gate)					
INPUTS OUTPUT					
Α	В	Y			
Н	Х	L			
Х	Н	L			
L	L	Н			

logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



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SCLS432A - SEPTEMBER 1999 - REVISED NOVEMBER 1999

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC} Input voltage range, V_I (see Note 1) Output voltage range, V_O (see Note 1) Input clamp current, I_{IK} ($V_I < 0$) Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) Continuous output current, I_O ($V_O = 0$ to V_{CC}) Continuous current through V_{CC} or GND Package thermal impedance, θ_{JA} (see Note 2)	$\begin{array}{ccc} -0.5 \mbox{ V to 7 V} \\ -0.5 \mbox{ V to V}_{CC} + 0.5 \mbox{ V} \\ -20 \mbox{ mA} \\ \pm 20 \mbox{ mA} \\ \pm 25 \mbox{ mA} \\ \pm 50 \mbox{ mA} \\ 296^{\circ}\mbox{C/W} \end{array}$
Package thermal impedance, θ_{JA} (see Note 2) Storage temperature range, T_{stg}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
VCC	Supply voltage		2	5.5	V
		V _{CC} = 2 V	1.5		
VIH	High-level input voltage	V _{CC} = 3 V	2.1		V
	VIL Low-level input voltage VI Input voltage VO Output voltage	V _{CC} = 5.5 V	3.85		
		$V_{CC} = 2 V$		0.5	
VIL	Low-level input voltage	V _{CC} = 3 V		0.9	V
		V _{CC} = 5.5 V		1.65	
VI	Input voltage		0	5.5	V
Vo	Output voltage		0	VCC	V
		$V_{CC} = 2 V$		-50	μΑ
ЮН	'IL Low-level input voltage 'I Input voltage 'O Output voltage OH High-level output current	V_{CC} = 3.3 V ± 0.3 V		-4	mA
		V_{CC} = 5 V ± 0.5 V		-8	ША
		$V_{CC} = 2 V$		50	μΑ
IOL	Low-level output current	V_{CC} = 3.3 V ± 0.3 V		4	m۸
		V_{CC} = 5 V ± 0.5 V		8	mA
A+/A>/	Input transition rise or fall rate	V_{CC} = 3.3 V ± 0.3 V		100	ns/V
ΔυΔν	V _{CC} = 5 V \pm 0.5 V			20	115/ V
TA	Operating free-air temperature		-40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



SCLS432A - SEPTEMBER 1999 - REVISED NOVEMBER 1999

PARAMETER	TEST CONDITIONS	Vcc	T _A = 25°C			MIN	MAY	UNIT
PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	IVITIN	MAX	UNIT
			1.9	2		1.9		
	I _{OH} = -50 μA	3 V	2.9	3		2.9		v
VOH		4.5 V	4.4	4.5		4.4		
	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		
	$I_{OH} = -8 \text{ mA}$	4.5 V	3.94			3.8		
		2 V			0.1		0.1	
	I _{OL} = 50 μA	3 V			0.1		0.1	
V _{OL}					0.1		0.1	V
	I _{OL} = 4 mA	3 V			0.36		0.44	
1	I _{OL} = 8 mA	4.5 V			0.36		0.44	
l	$V_{I} = V_{CC} \text{ or } GND$	5.5 V			±0.1		±1	μA
ICC	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V			1		10	μΑ
Ci	$V_I = V_{CC} \text{ or } GND$	5 V						pF

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

switching characteristics over recommended operating free-air temperature range,
V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

	PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T _A = 25°C	MIN MAX	UNIT		
					MIN TYP MAX		UNIT		
	^t PLH	A or B	v	C1 = 15 pF					
	^t PHL	AOLP	I				ns		
	^t PLH	A or B	v	$C_{\rm L} = 50 \rm pE$					
	^t PHL	AUB	T		CL = 50 pF	C _L = 50 pF			ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

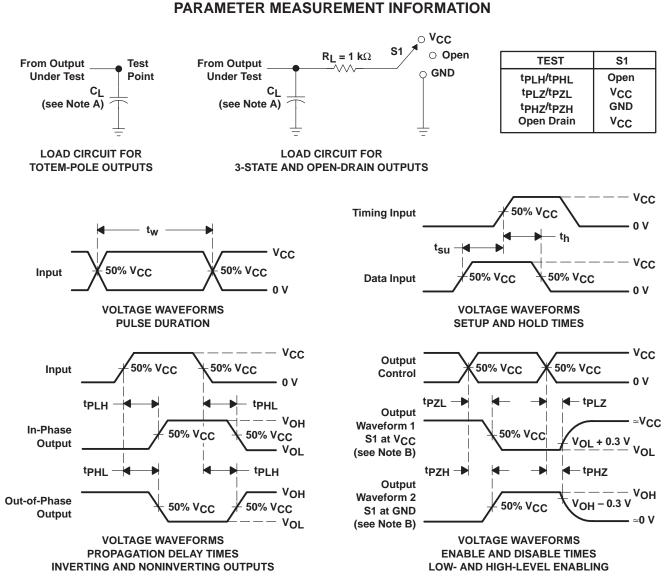
PARAMETER	FROM	TO (OUTPUT)	LOAD CAPACITANCE	T _A = 25°C	MIN MAX	UNIT
	(INPUT)			MIN TYP MAX		UNIT
^t PLH	A or B	V	C ₁ = 15 pF			ns
^t PHL	AOID	I	CL = 15 pr			115
^t PLH	A or B	V	C ₁ = 50 pF			ns
^t PHL	AUB	I	Ο <u>Γ</u> = 50 μr			115

operating characteristics, V_{CC} = 5 V, T_A = 25°C

	PARAMETER		ONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load,	f = 1 MHz		pF



SCLS432A - SEPTEMBER 1999 - REVISED NOVEMBER 1999



NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f \leq 3 ns, t_f \leq 3 ns.

D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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